11-30-2005

10/540515 Q88663

| | MODIFIED Form PTO-1595 (Rev. 10/02) | | | LET U.S. DEPARTMENT OF COMMERCE U.S. Patent and Trademark Office | | |
|---------|---|---|--------------------------|---|--|--|
| Ĺ | | 1021 | 107904 | 7 Rec'd (40 1700) 2.3 HIN 200 | | |
| ŀ | To the Director of the U.S. Paten | | | ned original documents or copy thereof. of receiving party(ies): | | |
| | Name of conveying party(ies): Tsuyoshi NAKANO | ! | | s or receiving party(les): EMICAL COMPANY, LIMITED | | |
| | Noboru FUKUHARA | Ī | 27-1, Shinkawa 2-6 | • | | |
| ı | | ļ | Chuo-ku, Tokyo, J | | | |
| | | ! | 2 STIMIKA EDI SOI | LUTION COMPANY, LTD. | | |
| | | ! | 27-1, Shinkawa 2-6 | | | |
| 0 | | | Chuo-ku, Tokyo, J | | | |
| ġ I | Additional name(s) of conveying party(ies) attached? | Yes 🗹 No | | | | |
| úΙ | 3. Nature of conveyance: | Ī | | | | |
| 0.57.00 | ✓ Assignment | ! | | | | |
| Š | ☐ Security Agreement ☐ Change of Name | | | | | |
| S | Other | ! | | | | |
| I | Execution Date: May 26, 2005 | | Additional name(s) & ac | ddress(es) attached? ☐ Yes ☐ No | | |
| | 4. Application number(s) or patent number(s): | | A Maria Comment | datess(vs) mineral. 2 - 10 | | |
| | If this document is being filed together with a new application, the execution date of the application is: May 26, 2005 | | | | | |
| • | A. Patent Application No.(s) | i | B. Patent No.(s) | | | |
| • | Unassigned | ! | | | | |
| | Additio | Additional numbers attached? ☐ Yes ☑ No | | | | |
| | 5. Name and address of party to whom correspondence oncerning document should be mailed: | ondence | 6. Total number of ap | pplications and patents involved: | | |
| | SUGHRUE MION, PLLC | ļ | 7. Total fee (37 CFR | 3.41): \$40.00 | | |
| | WASHINGTON OFFICE | ļ | ☑ Enclosed. | | | |
| 1 | 23373 | ļ | | be charged to Deposit Account No. 19-4880. | | |
| 1 | CUSTOMER NUMBER | ļ | | ected and authorized to charge all required sue Fee and the Publication Fee, to Deposit | | |
| 1 | | , | |). Please also credit any overpayments to said | | |
| 06/3 | 0/2005 GFREY1 00000095 10540515 | ! | Deposit Account. | | | |
| 05 F | 2:8021 40.00 QP | ļ | 8. Deposit Account N | | | |
| | | 1 | (Attach duplicate | 19-4880 copy of this page if paying by deposit account) | | |
| - | | DO NOT | USE THIS SPACE | copy of and page in paying of actions. | | |
| I | 9. Statement and signature. | | | | | |
| I | To the best of my knowledge and belief, the f | oregoing info | rmation is true and cori | rect and any attached copy is a true copy of the | | |
| I | original document. | 0 - | | | | |
| | Blan Callation | | | June 23, 2005 | | |
| | John T. Callahan | Reg. No. | 32,607 | Date | | |
| | V Total number of pages including cover sheet, attachments, and documents: 2 | | | | | |
| ŀ | Mail documents to be recorded with required cover sheet information to: | | | | | |
| Ī | MAIL STOP | ASSIGNME | ENT RECORDATION | SERVICES | | |
| 1 | Director of the U.S. Patent and Trademark Office P.O. Box 1450 Alexandria, VA 22313-1450 | | | | | |
| | | | | | | |

PATENT

REEL: 017291 FRAME: 0180

ASSIGNMENT

As a below named inventor, I hereby declare that:

RECORDED: 06/23/2005

IN CONSIDERATION of the sum of One Dollar(\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by SUMITOMO CHEMICAL COMPANY, LIMITED, and Sumika Epi Solution Company, Ltd., corporations organized under the laws of Japan, located at 27-1, Shinkawa 2-chome, Chuo-ku, Tokyo, Japan, and 27-1, Shinkawa 2-chome, Chuo-ku, Tokyo, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said SUMITOMO CHEMICAL COMPANY, LIMITED, and Sumika Epi Solution Company, Ltd., their successors and assigns, all my right, title and interest, in and for the United States of America, in and to COMPOUND SEMICONDUCTOR EPITAXIAL SUBSTRATE AND METHOD FOR MANUFACTURING THE SAME

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith,

and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said SUMITOMO CHEMICAL COMPANY, LIMITED, and Sumika Epi Solution Company, Ltd., their successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said SUMITOMO CHEMICAL COMPANY, LIMITED., and Sumika Epi Solution Company, Ltd.

| | Signed on the date(s) indicated aside signatures: | | | | | |
|-----------------|---|--------------|-------------|--|--|--|
| | INVENTOR (S) | Date Signed | WITNESSES | | | |
| | (発明者フルネームサイン) | (署名日) | (立会人サイン) | | | |
| 1) . | <u>Lsuyoshi</u> Nakano Tsuyoshi NAKANO | May 26, 2005 | Akira Incal | | | |
| 2) . | Motori Entura a Noboru FUKUHARA | May 26, 200t | Akira Inone | | | |
| 3) _ | | | | | | |
| 4) . | | | | | | |
| 5) ₋ | | | | | | |
| 6) _ | | | | | | |
| 7) _ | | | | | | |
| 8) _ | | | | | | |

PATENT REEL: 017291 FRAME: 0181